Lattice Semiconductor Corporation - LFE2-20SE-7QN208C Datasheet

Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Not For New Designs
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	131
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-7qn208c

LatticeECP2/M Family Data Sheet Architecture

September 2013 **Data Sheet DS1006**

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sysDSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

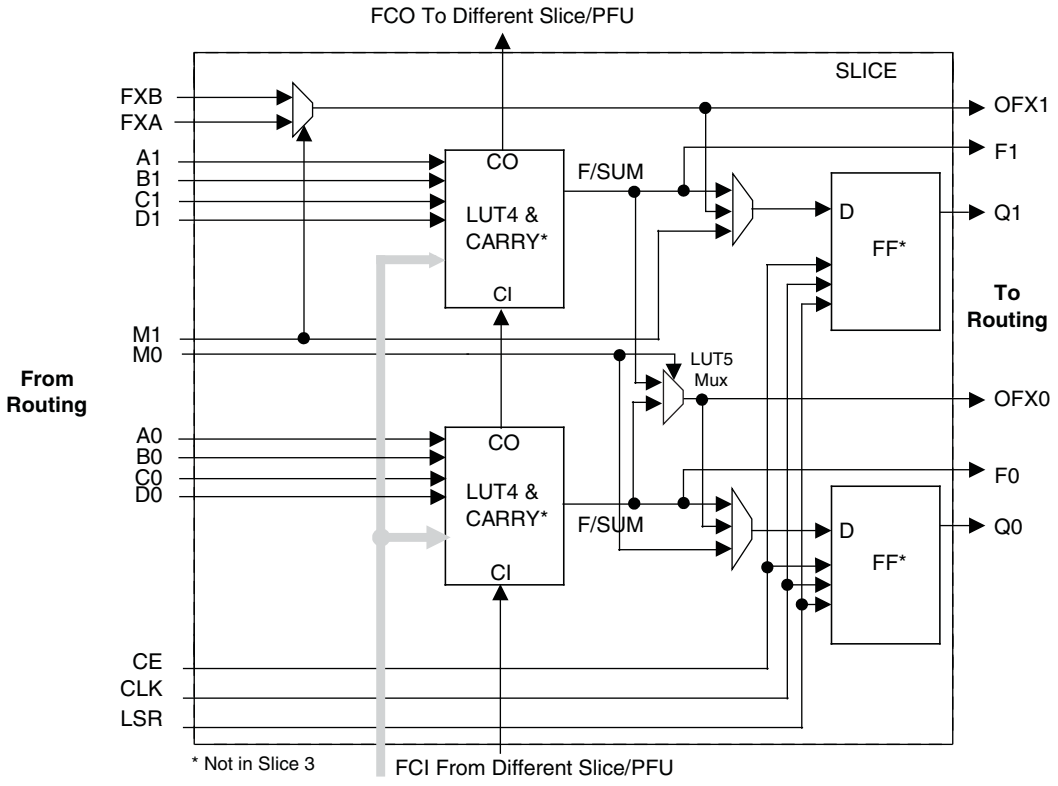
The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Figure 2-4. Slice Diagram



For Slices 0 and 2, memory control signals are generated from Slice 1 as follows:

WCK is CLK
WRE is from LSR
DI[3:2] for Slice 2 and DI[1:0] for Slice 0 data
WAD [A:D] is a 4bit address from slice 1 LUT input

Table 2-2. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FC	Fast Carry-in[1]
Input	Inter-slice signal	FXA	Intermediate signal to generate LUT6 and LUT7
Input	Inter-slice signal	FXB	Intermediate signal to generate LUT6 and LUT7
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8[2] MUX depending on the slice
Output	Inter-PFU signal	FCO	Slice 2 of each PFU is the fast carry chain output[1]

1. See Figure 2-4 for connection details.
2. Requires two PFUs.

MLVDS

The LatticeECP2/M devices support the differential MLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The MLVDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-5 is one possible solution for MLVDS standard implementation. Resistor values in Figure 3-5 are industry standard values for 1% resistors.

Figure 3-5. MLVDS (Multipoint Low Voltage Differential Signaling)

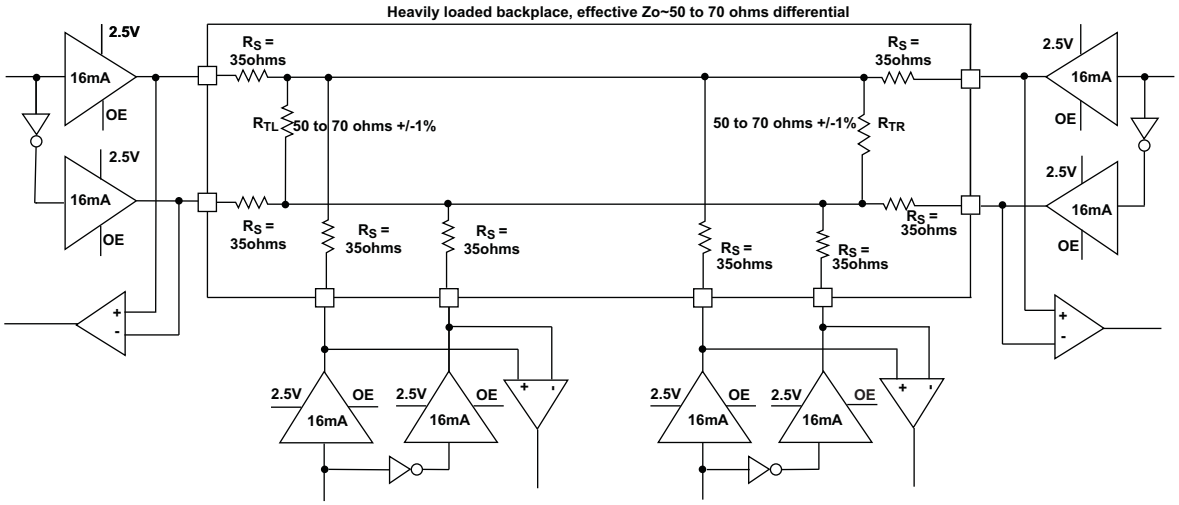


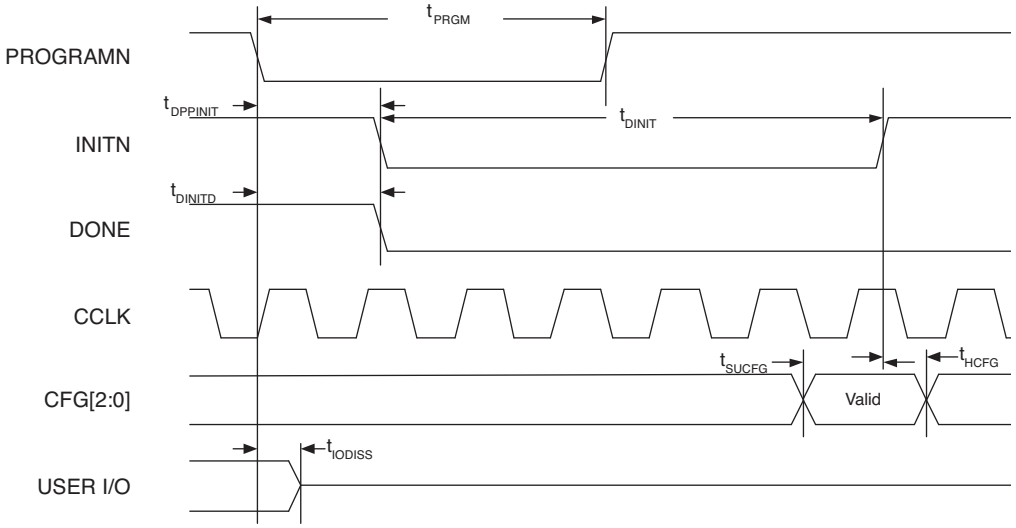
Table 3-6. MLVDS DC Conditions[1]

Parameter	Description	Typical		Units
		Zo=50Ω	Zo=70Ω	
V_{CCIO}	Output Driver Supply (+/-5%)	2.50	2.50	V
Z_{OUT}	Driver Impedance	10.00	10.00	Ω
R_S	Driver Series Resistor (+/-1%)	35.00	35.00	Ω
R_{TL}	Driver Parallel Resistor (+/-1%)	50.00	70.00	Ω
R_{TR}	Receiver Termination (+/-1%)	50.00	70.00	Ω
V_{OH}	Output High Voltage	1.52	1.60	V
V_{OL}	Output Low Voltage	0.98	0.90	V
V_{OD}	Output Differential Voltage	0.54	0.70	V
V_{CM}	Output Common Mode Voltage	1.25	1.25	V
I_{DC}	DC Output Current	21.74	20.00	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

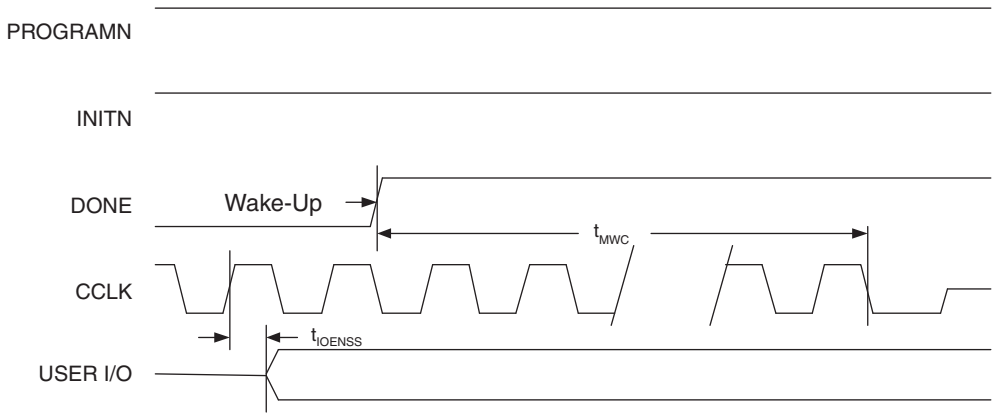
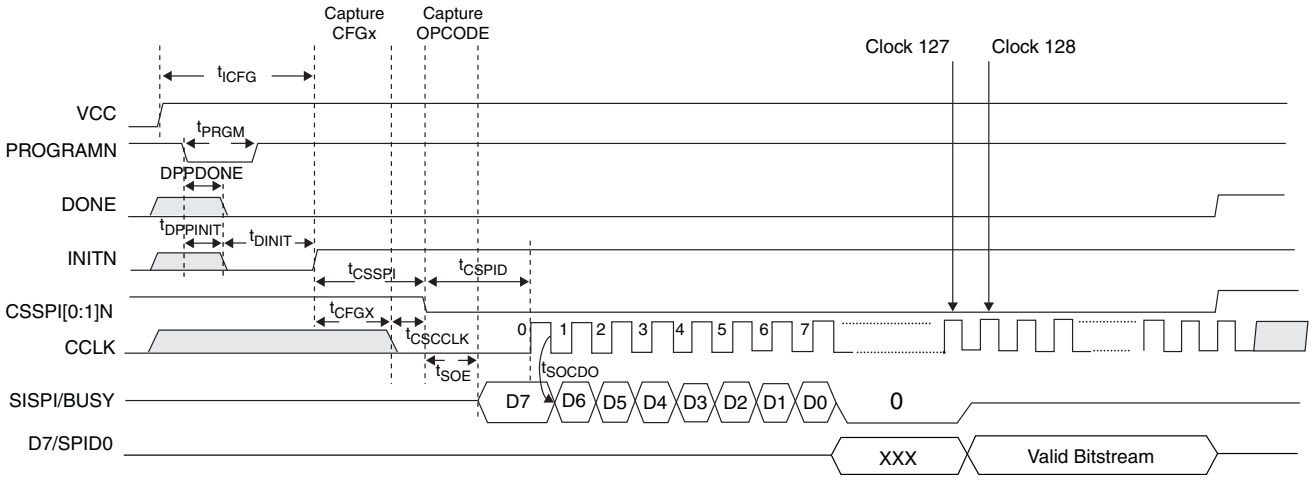


Figure 3-20. SPI/SPIm Configuration Waveforms



Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See "Typical sysI/O I/O Behavior During Power-up" for more information about I/O behavior during power-up.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V_{CC}	—	Power supply pins for core logic. Dedicated pins.
V_{CCAUX}	—	Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers.
V_{CCIOx}	—	Dedicated power supply pins for I/O bank x.
V_{CCPLL}	—	PLL supply pins. Should be tied to V_{CC} even when the corresponding PLL is unused.
V_{REF1_x}, V_{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V_{REF} inputs. When not used, they may be used as I/O pins.
XRES[4]	—	10K ohm +/-1% resistor must be connected between this pad and ground.
PLLCAP[4]	—	External capacitor connection for PLL.
PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_V_{CCPLL}	—	Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center.
[LOC][num]_GPLL[T, C]_IN_A	I	General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_GPLL[T, C]_FB_A	I	Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_IN_A[5]	I	Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_FB_A[5]	I	Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_IN_A	I	DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_FB_A	I	Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
91	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*
92	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*
93	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
94	VCC	-			VCC	-		
95	GND	-			GND	-		
96	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
97	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
98	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
99	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
100	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
101	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
102	VCC	-			VCC	-		
103	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
104	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T
105	GND	-			GND	-		
106	VCCIO2	2			VCCIO2	2		
107	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
108	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
109	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C
110	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T
111	PT26B	1		C	PT54B	1		C
112	PT26A	1		T	PT54A	1		T
113	PT24B	1		C	PT52B	1		C
114	PT24A	1		T	PT52A	1		T
115	PT22B	1		C	PT50B	1		C
116	PT22A	1		T	PT50A	1		T
117	VCCIO1	1			VCCIO1	1		
118	PT20B	1		C	PT48B	1		C
119	PT20A	1		T	PT48A	1		T
120	GND	-			GND	-		
121	PT18B	1		C	PT44B	1		C
122	PT18A	1		T	PT44A	1		T
123	PT16A	1			PT40B	1		C
124	NC	1			PT40A	1		T
125	PT14B	1		C	PT34B	1		C
126	PT14A	1		T	PT34A	1		T
127	NC	1			NC	1		
128	VCC	-			VCC	-		
129	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C
130	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T
131	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C
132	XRES	0			XRES	0		
133	GND	-			GND	-		
134	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T
135	VCC	-			VCC	-		

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
136	PT6B	0		C	PT16B	0		C
137	PT6A	0		T	PT16A	0		T
138	GND	-			GND	-		
139	VCCIO0	0			VCCIO0	0		
140	PT4B	0		C	PT6B	0		C
141	PT4A	0		T	PT6A	0		T
142	VCCAUX	-			VCCAUX	-		
143	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
144	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
R8	VCCIO6	6			VCCIO6	6		
J8	VCCIO7	7			VCCIO7	7		
K7	VCCIO7	7			VCCIO7	7		
L7	VCCIO7	7			VCCIO7	7		
M7	VCCIO7	7			VCCIO7	7		
P15	VCCIO8	8			VCCIO8	8		
R15	VCCIO8	8			VCCIO8	8		
C5	VCCAUX	-			VCCAUX	-		
D11	VCCAUX	-			VCCAUX	-		
E17	VCCAUX	-			VCCAUX	-		
E6	VCCAUX	-			VCCAUX	-		
F13	VCCAUX	-			VCCAUX	-		
G18	VCCAUX	-			VCCAUX	-		
G5	VCCAUX	-			VCCAUX	-		
K5	VCCAUX	-			VCCAUX	-		
M17	VCCAUX	-			VCCAUX	-		
P17	VCCAUX	-			VCCAUX	-		
R5	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V13	VCCAUX	-			VCCAUX	-		
V15	VCCAUX	-			VCCAUX	-		
V7	VCCAUX	-			VCCAUX	-		
V8	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A22	GND	-			GND	-		
AA19	GND	-			GND	-		
AA4	GND	-			GND	-		
AB1	GND	-			GND	-		
AB22	GND	-			GND	-		
B19	GND	-			GND	-		
B4	GND	-			GND	-		
C14	GND	-			GND	-		
C9	GND	-			GND	-		
D2	GND	-			GND	-		
D21	GND	-			GND	-		
F17	GND	-			GND	-		
F6	GND	-			GND	-		
H10	GND	-			GND	-		
H11	GND	-			GND	-		
H12	GND	-			GND	-		
H13	GND	-			GND	-		
J14	GND	-			GND	-		
J20	GND	-			GND	-		
J3	GND	-			GND	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y21	PB64A	4	VREF2_4/BDQ60	T	PB73A	4	VREF2_4/BDQ69	T
AB23	PB64B	4	VREF1_4/BDQ60	C	PB73B	4	VREF1_4/BDQ69	C
GND	GNDIO4	-			GNDIO4	-		
AD24	CFG2	8			CFG2	8		
W20	CFG1	8			CFG1	8		
AC24	CFG0	8			CFG0	8		
V19	PROGRAMN	8			PROGRAMN	8		
AA22	CCLK	8			CCLK	8		
AB24	INITN	8			INITN	8		
AD25	DONE	8			DONE	8		
GND	GNDIO8	-			GNDIO8	-		
W21	PR44B	8	WRITEN	C	PR58B	8	WRITEN	C
Y22	PR44A	8	CS1N	T	PR58A	8	CS1N	T
AC25	PR43B	8	CSN	C	PR57B	8	CSN	C
AB25	PR43A	8	D0/SPIFASTN	T	PR57A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8			VCCIO8	8		
AD26	PR42B	8	D1	C	PR56B	8	D1	C
AC26	PR42A	8	D2	T	PR56A	8	D2	T
Y23	PR41B	8	D3	C	PR55B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
W22	PR41A	8	D4	T	PR55A	8	D4	T
AA25	PR40B	8	D5	C	PR54B	8	D5	C
AB26	PR40A	8	D6	T	PR54A	8	D6	T
W23	PR39B	8	D7/SPID0	C	PR53B	8	D7/SPID0	C
VCCIO	VCCIO8	8			VCCIO8	8		
V22	PR39A	8	DI/CSSPI0N	T	PR53A	8	DI/CSSPI0N	T
Y24	PR38B	8	DOUT/CSON	C	PR52B	8	DOUT/CSON	C
Y25	PR38A	8	BUSY/SISPI	T	PR52A	8	BUSY/SISPI	T
W24	PR37B	3	RDQ34	C	PR51B	3	RDQ48	C
GND	GNDIO3	-			GNDIO3	-		
V23	PR37A	3	RDQ34	T	PR51A	3	RDQ48	T
AA26	PR36B	3	RDQ34	C (LVDS)*	PR50B	3	RDQ48	C (LVDS)*
Y26	PR36A	3	RDQ34	T (LVDS)*	PR50A	3	RDQ48	T (LVDS)*
U21	PR35B	3	RDQ34	C	PR49B	3	RDQ48	C
VCCIO	VCCIO3	3			VCCIO3	3		
U19	PR35A	3	RDQ34	T	PR49A	3	RDQ48	T
W25	PR34B	3	RDQ34	C (LVDS)*	PR48B	3	RDQ48	C (LVDS)*
W26	PR34A	3	RDQS34	T (LVDS)*	PR48A	3	RDQS48	T (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
V24	PR33B	3	RDQ34	C	PR47B	3	RDQ48	C
V25	PR33A	3	RDQ34	T	PR47A	3	RDQ48	T
V26	PR32B	3	RDQ34	C (LVDS)*	PR46B	3	RDQ48	C (LVDS)*
U26	PR32A	3	RDQ34	T (LVDS)*	PR46A	3	RDQ48	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
U22	PR31B	3	RLM0_GPLLC_FB_A/RDQ34	C	PR45B	3	RLM0_GPLLC_FB_A/RDQ48	C
U23	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T	PR45A	3	RLM0_GPLLT_FB_A/RDQ48	T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D4	PT7B	0		C	PT7B	0		C
D3	PT7A	0		T	PT7A	0		T
C2	PT6B	0		C	PT6B	0		C
C1	PT6A	0		T	PT6A	0		T
G8	PT5B	0		C	PT5B	0		C
GND	GNDIO0	-			GNDIO0	-		
G7	PT5A	0		T	PT5A	0		T
E7	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
F7	PT4A	0		T	PT4A	0		T
E6	PT3B	0		C	PT3B	0		C
E5	PT3A	0		T	PT3A	0		T
G6	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
G5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T
L12	VCC	-			VCC	-		
L13	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L15	VCC	-			VCC	-		
M11	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M15	VCC	-			VCC	-		
M16	VCC	-			VCC	-		
N11	VCC	-			VCC	-		
N16	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
R11	VCC	-			VCC	-		
R12	VCC	-			VCC	-		
R15	VCC	-			VCC	-		
R16	VCC	-			VCC	-		
T12	VCC	-			VCC	-		
T13	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T15	VCC	-			VCC	-		
D11	VCCIO0	0			VCCIO0	0		
D6	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	0		
J12	VCCIO0	0			VCCIO0	0		
D16	VCCIO1	1			VCCIO1	1		
D21	VCCIO1	1			VCCIO1	1		
G18	VCCIO1	1			VCCIO1	1		
J15	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
F23	VCCIO2	2			VCCIO2	2		
J20	VCCIO2	2			VCCIO2	2		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
GNDIO	GNDIO7	-		
L1	PL36A	7	LDQS36	T (LVDS)*
L2	PL36B	7	LDQ36	C (LVDS)*
M7	PL37A	7	LDQ36	T
VCCIO	VCCIO7	7		
L5	PL37B	7	LDQ36	C
L3	PL38A	7	LDQ36	T (LVDS)*
L4	PL38B	7	LDQ36	C (LVDS)*
M1	PL39A	7	PCLKT7_0/LDQ36	T
GNDIO	GNDIO7	-		
M2	PL39B	7	PCLKC7_0/LDQ36	C
M6	PL41A	6	PCLKT6_0	T (LVDS)*
M5	PL41B	6	PCLKC6_0	C (LVDS)*
M3	PL42A	6	VREF2_6	T
M4	PL42B	6	VREF1_6	C
VCCIO	VCCIO6	6		
N7	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO6	-		
N6	PL45B	6	LLM3_SPLLC_IN_A	C (LVDS)*
N1	PL46A	6	LLM3_SPLLT_FB_A	T
N2	PL46B	6	LLM3_SPLLC_FB_A	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
P6	PL52A	6	LDQS52****	T (LVDS)*
N5	PL52B	6	LDQ52	C (LVDS)*
P1	PL53A	6	LDQ52	T
VCCIO	VCCIO6	6		
P2	PL53B	6	LDQ52	C
P3	PL54A	6	LDQ52	T (LVDS)*
P4	PL54B	6	LDQ52	C (LVDS)*
P5	PL55A	6	LDQ52	T
GNDIO	GNDIO6	-		
P7	PL55B	6	LDQ52	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
R1	PL62A	6	LLM0_GPLLT_IN_A**	T (LVDS)*
GNDIO	GNDIO6	-		
R2	PL62B	6	LLM0_GPLLC_IN_A**	C (LVDS)*
R3	PL63A	6	LLM0_GPLLT_FB_A	T
R4	PL63B	6	LLM0_GPLLC_FB_A	C
VCCIO	VCCIO6	6		
R6	PL64A	6	LLM0_GDLLT_IN_A**	T (LVDS)*
R5	PL64B	6	LLM0_GDLLC_IN_A**	C (LVDS)*

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
W19	NC	-		
W18	NC	-		
V17	NC	-		
V18	NC	-		
D15	NC	-		
G14	NC	-		
G15	NC	-		
D14	NC	-		
E15	NC	-		
E14	NC	-		
F15	NC	-		
F14	NC	-		
F13	NC	-		
G12	NC	-		
G13	NC	-		
H8	VCCPLL	-		
H15	VCCPLL	-		
R8	VCCPLL	-		
R15	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).
****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AF23	PB64A	4	BDQ60	T	LRC_SQ_HDINP1	13		T
AD23	NC	-			LRC_SQ_VCCIB1	13		
AE23	PB66B	4	BDQ69	C	LRC_SQ_HDINN1	13		C
AD24	VCC	-			LRC_SQ_VCCRX1	13		
AF20	PB55A	4	BDQ51	T	LRC_SQ_HDOUTP1	13		T
AD20	NC	-			LRC_SQ_VCCOB1	13		
AE20	PB55B	4	BDQ51	C	LRC_SQ_HDOUTN1	13		C
AD21	VCC	-			LRC_SQ_VCCTX1	13		
AE21	PB63B	4	BDQ60	C	LRC_SQ_HDOUTN0	13		C
AF22	NC	-			LRC_SQ_VCCOB0	13		
AF21	PB62A	4	BDQ60	T	LRC_SQ_HDOUTP0	13		T
AD22	VCC	-			LRC_SQ_VCCTX0	13		
AE24	PB67B	4	BDQ69	C	LRC_SQ_HDINN0	13		C
AE25	NC	-			LRC_SQ_VCCIB0	13		
AF24	PB67A	4	BDQ69	T	LRC_SQ_HDINP0	13		T
AD25	VCC	-			LRC_SQ_VCCRX0	13		
AA21	CFG2	8			CFG2	8		
AA22	CFG1	8			CFG1	8		
AB23	CFG0	8			CFG0	8		
AC26	PROGRAMN	8			PROGRAMN	8		
AB24	CCLK	8			CCLK	8		
AA23	INITN	8			INITN	8		
AB25	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
Y19	PR68B	8	WRITEN***	C	WRITEN***	8		
Y21	PR68A	8	CS1N***	T	CS1N***	8		
AB26	PR67B	8	CSN***	C	CSN***	8		
Y22	PR67A	8	D0/SPIFASTN***	T	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8				8		
W19	PR66B	8	D1***	C	D1***	8		
Y20	PR66A	8	D2***	T	D2***	8		
W22	PR65B	8	D3***	C	D3***	8		
GNDIO	GNDIO8	-				-		
W18	PR65A	8	D4***	T	D4***	8		
Y23	PR64B	8	D5***	C	D5***	8		
AA24	PR64A	8	D6***	T	D6***	8		
W21	PR63B	8	D7/SPID0***	C	D7/SPID0***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
V20	PR63A	8	DI/CSSPI0N***	T	DI/CSSPI0N***	8		
W23	PR62B	8	DOUT/CSON/CSSPI1N***	C	DOUT/CSON/ CSSPI1N***	8		
Y24	PR62A	8	BUSY/SISPI***	T	BUSY/SISPI***	8		
V19	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
V21	PR60B	3	RLM0_GDLLC_FB_A	C	PR65B	3	RLM0_GDLLC_FB_A	C
GNDIO	GNDIO3	-			GNDIO3	-		
U19	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T	PR65A	3	RLM0_GDLLT_FB_A	T
AA26	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*	PR64B	3	RLM0_GDLLC_IN_A	C*
Y26	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*	PR64A	3	RLM0_GDLLT_IN_A	T*
V23	PR58B	3	RLM0_GPLLC_IN_A**/RDQ57	C	PR63B	3	RLM0_GPLLC_IN_A	C

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AJ17	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
AF26	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
AE25	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
AD24	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AE24	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AD18	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T
AC18	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C
AE18	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T
AG19	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AC19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T
AD20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C
AB18	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T
AC20	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C
AE20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T
AE21	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
AC23	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T
AD23	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C
GNDIO	GNDIO4	-			GNDIO4	-		
AH18	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13		
AK19	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T
AJ18	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13		
AJ19	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C
AH21	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13		
AK22	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T
AK21	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13		
AJ22	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C
AH22	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13		
AJ23	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C
AH23	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13		
AK23	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T
AH19	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13		
AJ20	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AH20	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AK20	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AH24	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AG24	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AF24	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AJ24	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AK28	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AH28	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AJ28	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AH29	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13		
AK25	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
GNDIO	GNDIO2	-		
M27	PR47B	2	RDQ45	C (LVDS)*
M28	PR47A	2	RDQ45	T (LVDS)*
H30	PR46B	2	RDQ45	C
G30	PR46A	2	RDQ45	T
VCCIO	VCCIO2	2		
M25	PR45B	2	RDQ45	C (LVDS)*
M26	PR45A	2	RDQS45	T (LVDS)*
L30	PR44B	2	RDQ45	C
GNDIO	GNDIO2	-		
L29	PR44A	2	RDQ45	T
L28	PR43B	2	RDQ45	C (LVDS)*
L27	PR43A	2	RDQ45	T (LVDS)*
H29	PR42B	2	RDQ45	C
VCCIO	VCCIO2	2		
G29	PR42A	2	RDQ45	T
L22	PR41B	2	RDQ45	C (LVDS)*
M22	PR41A	2	RDQ45	T (LVDS)*
F30	PR40B	2		C
GNDIO	GNDIO2	-		
F29	PR40A	2		T
VCCIO	VCCIO2	2		
GNDIO	GNDIO2	-		
E30	PR34B	2	RDQ32	C (LVDS)*
E29	PR34A	2	RDQ32	T (LVDS)*
-	-	-		
L25	PR33B	2	RDQ32	C
L26	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2		
H28	PR32B	2	RDQ32	C (LVDS)*
J28	PR32A	2	RDQS32	T (LVDS)*
G28	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-		
G27	PR31A	2	RDQ32	T
L24	PR30B	2	RDQ32	C (LVDS)*
L23	PR30A	2	RDQ32	T (LVDS)*
D30	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2		
D29	PR29A	2	RDQ32	T
K24	PR28B	2	RDQ32	C (LVDS)*
K25	PR28A	2	RDQ32	T (LVDS)*
J27	PR26B	2	RDQ23	C
GNDIO	GNDIO2	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
A9	ULC_SQ_HDOUTP0	11		T
A10	ULC_SQ_VCCOB0	11		
B9	ULC_SQ_HDOUTN0	11		C
C9	ULC_SQ_VCCTX1	11		
B8	ULC_SQ_HDOUTN1	11		C
C8	ULC_SQ_VCCOB1	11		
A8	ULC_SQ_HDOUTP1	11		T
C12	ULC_SQ_VCCRX1	11		
B11	ULC_SQ_HDINN1	11		C
C11	ULC_SQ_VCCIB1	11		
A11	ULC_SQ_HDINP1	11		T
B7	ULC_SQ_VCCAUX33	11		
E7	ULC_SQ_REFCLKN	11		C
D7	ULC_SQ_REFCLKP	11		T
C7	ULC_SQ_VCCP	11		
A3	ULC_SQ_HDINP2	11		T
C3	ULC_SQ_VCCIB2	11		
B3	ULC_SQ_HDINN2	11		C
C2	ULC_SQ_VCCRX2	11		
A6	ULC_SQ_HDOUTP2	11		T
C6	ULC_SQ_VCCOB2	11		
B6	ULC_SQ_HDOUTN2	11		C
C5	ULC_SQ_VCCTX2	11		
B5	ULC_SQ_HDOUTN3	11		C
A4	ULC_SQ_VCCOB3	11		
A5	ULC_SQ_HDOUTP3	11		T
C4	ULC_SQ_VCCTX3	11		
B2	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11		
A2	ULC_SQ_HDINP3	11		T
C1	ULC_SQ_VCCRX3	11		
L12	VCC	-		
L13	VCC	-		
L18	VCC	-		
L19	VCC	-		
M11	VCC	-		
M12	VCC	-		
M13	VCC	-		
M14	VCC	-		
M15	VCC	-		
M16	VCC	-		
M17	VCC	-		
M18	VCC	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AE12	NC	-			NC	-		
AE13	NC	-			NC	-		
AE19	NC	-			NC	-		
AE21	NC	-			NC	-		
AE22	NC	-			NC	-		
AE23	NC	-			NC	-		
AF11	NC	-			NC	-		
AF21	NC	-			NC	-		
AF22	NC	-			NC	-		
AF24	NC	-			NC	-		
AF8	NC	-			NC	-		
AF9	NC	-			NC	-		
AG10	NC	-			NC	-		
AG11	NC	-			NC	-		
AG24	NC	-			NC	-		
AG25	NC	-			NC	-		
AG26	NC	-			NC	-		
AG3	NC	-			NC	-		
AG7	NC	-			NC	-		
AG8	NC	-			NC	-		
AG9	NC	-			NC	-		
AH10	NC	-			NC	-		
AH11	NC	-			NC	-		
AH13	NC	-			NC	-		
AH24	NC	-			NC	-		
AH25	NC	-			NC	-		
AH26	NC	-			NC	-		
AH27	NC	-			NC	-		
AH5	NC	-			NC	-		
AH6	NC	-			NC	-		
AH7	NC	-			NC	-		
AH8	NC	-			NC	-		
AH9	NC	-			NC	-		
AJ10	NC	-			NC	-		
AJ11	NC	-			NC	-		
AJ13	NC	-			NC	-		
AJ24	NC	-			NC	-		
AJ25	NC	-			NC	-		
AJ26	NC	-			NC	-		
AJ27	NC	-			NC	-		
AJ3	NC	-			NC	-		
AJ4	NC	-			NC	-		
AJ5	NC	-			NC	-		
AJ6	NC	-			NC	-		
AJ7	NC	-			NC	-		
AJ8	NC	-			NC	-		
AJ9	NC	-			NC	-		
AK10	NC	-			NC	-		
AK11	NC	-			NC	-		